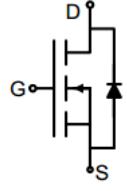
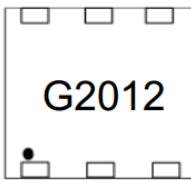
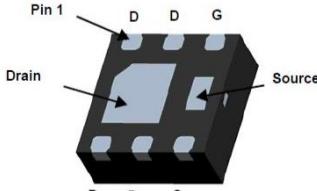


N-Channel Enhancement Mode Power MOSFET

<p>Description</p> <p>The G2012 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.</p> <p>General Features</p> <ul style="list-style-type: none"> ● V_{DS} 20V ● I_D (at $V_{GS} = 10V$) 12A ● $R_{DS(ON)}$ (at $V_{GS} = 4.5V$) < 12mΩ ● $R_{DS(ON)}$ (at $V_{GS} = 2.5V$) < 18mΩ ● 100% Avalanche Tested ● RoHS Compliant <p>Application</p> <ul style="list-style-type: none"> ● Power switch ● DC/DC converters 	 <p>Schematic diagram</p>  <p>Marking and pin assignment</p>  <p>DFN2*2-6L</p>		
Device	Package	Marking	Packaging
G2012	DFN2*2-6L	G2012	3000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, unless otherwise noted			
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	20	V
Continuous Drain Current	I_D	12	A
Pulsed Drain Current (note1)	I_{DM}	40	A
Gate-Source Voltage	V_{GSS}	± 10	V
Power Dissipation	P_D	1.5	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	$^\circ\text{C}$

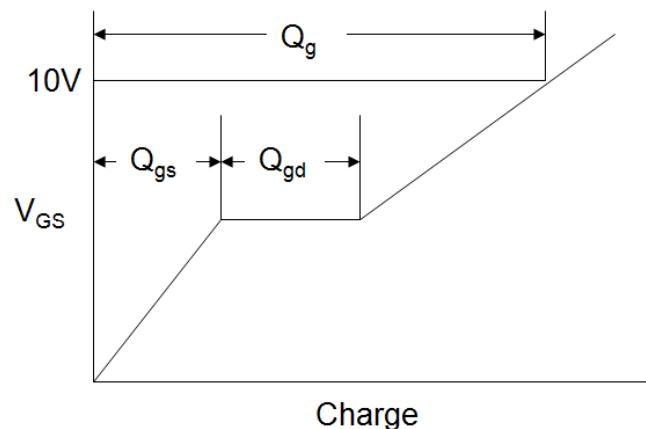
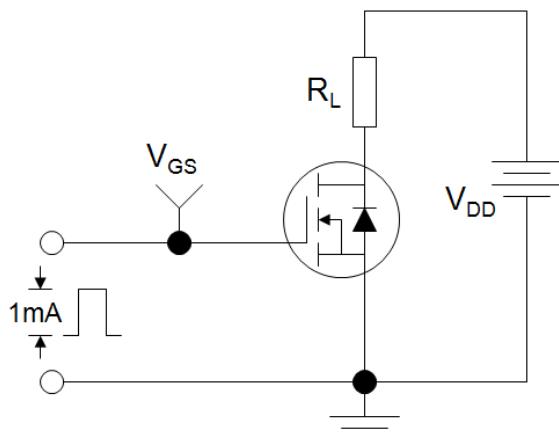
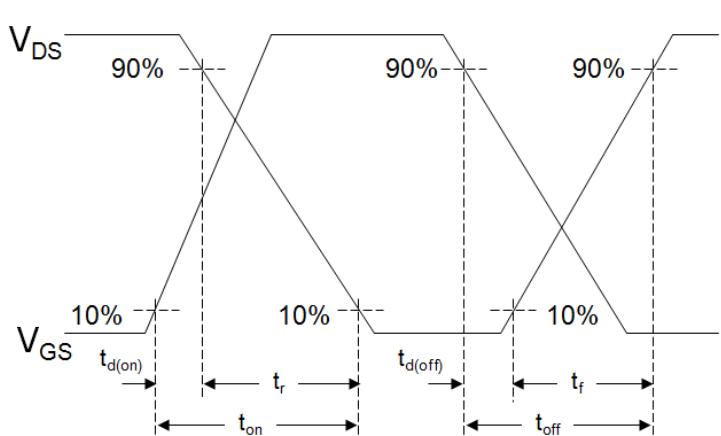
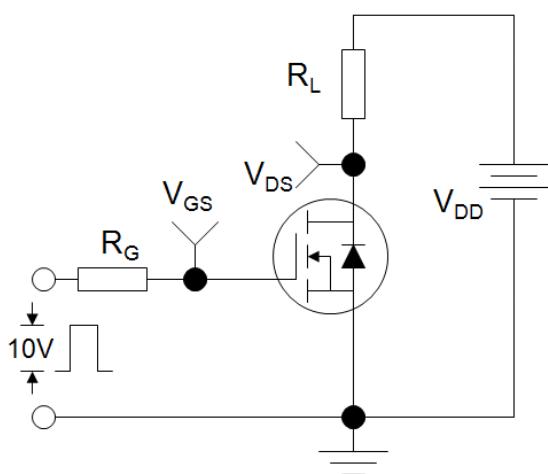
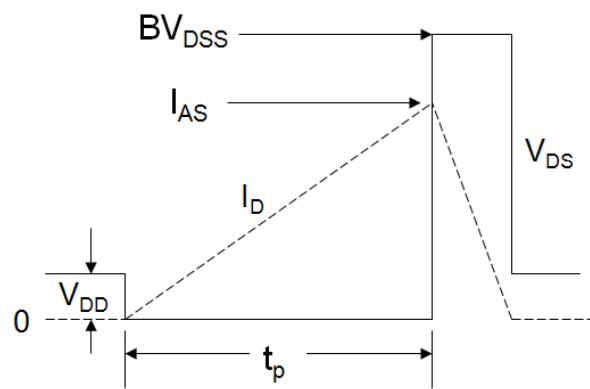
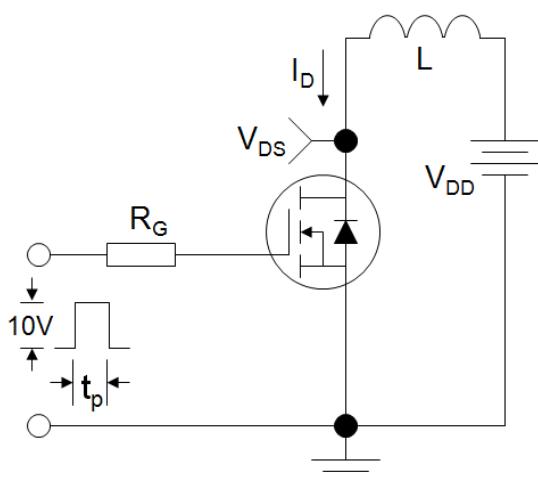
Thermal Resistance			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	83	$^\circ\text{C/W}$

Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	20	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, T_J = 25^\circ\text{C}$	--	--	1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 10\text{V}$	--	--	± 100	nA
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.35	0.7	1	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = 4.5\text{V}, I_D = 5\text{A}$	--	7.3	12	$\text{m}\Omega$
		$V_{GS} = 2.5\text{V}, I_D = 5\text{A}$	--	8.8	18	
Forward Transconductance	g_{FS}	$V_{DS}=10\text{V}, I_D=5\text{A}$	--	5	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}, V_{DS} = 10\text{V}, f = 1.0\text{MHz}$	--	1255	--	pF
Output Capacitance	C_{oss}		--	220	--	
Reverse Transfer Capacitance	C_{rss}		--	180	--	
Total Gate Charge	Q_g	$V_{DD} = 10\text{V}, I_D = 10\text{A}, V_{GS} = 10\text{V}$	--	29	--	nC
Gate-Source Charge	Q_{gs}		--	5.2	--	
Gate-Drain Charge	Q_{gd}		--	6.3	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = 10\text{V}, I_D = 5\text{A}, R_G = 50\Omega$	--	300	--	ns
Turn-on Rise Time	t_r		--	1000	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	4000	--	
Turn-off Fall Time	t_f		--	2500	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	12	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = 10\text{A}, V_{GS} = 0\text{V}$	--	--	1.2	V

Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

Gate Charge Test Circuit**EAS Test Circuit****Switch Time Test Circuit**

Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

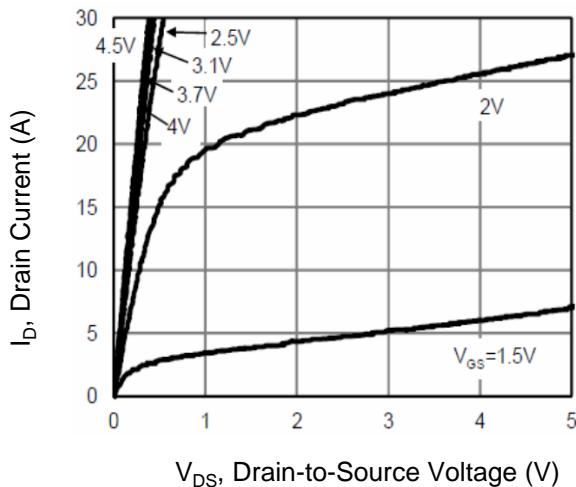


Figure 2. Transfer Characteristics

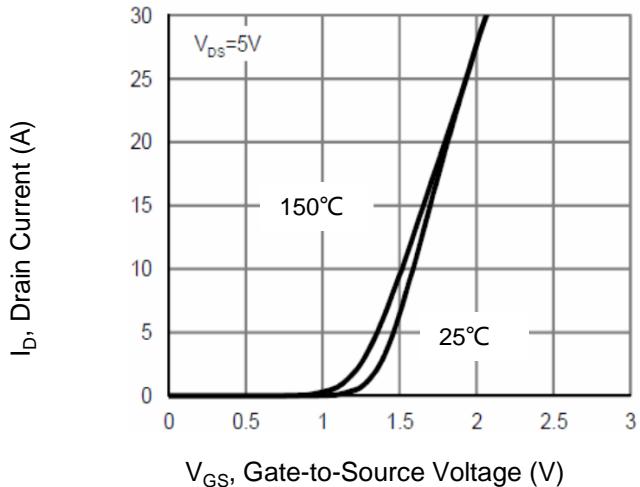


Figure 3.Rdson-Drain Current

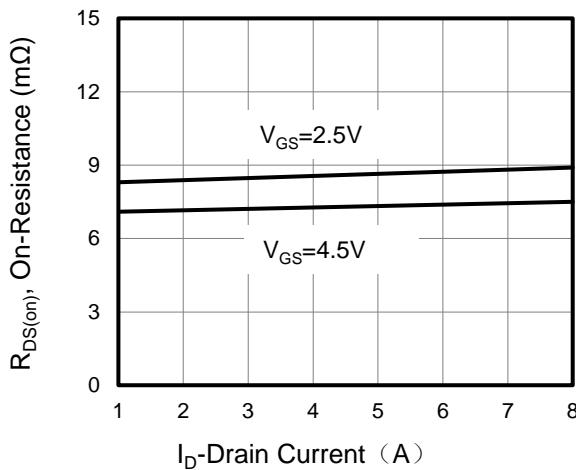


Figure 4. Gate Charge

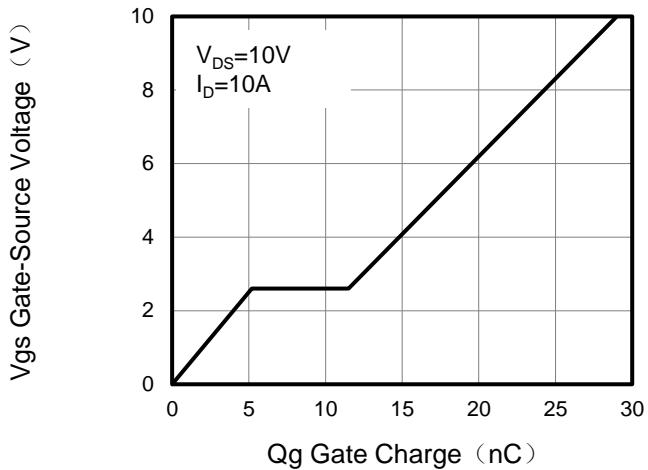


Figure 5. Capacitance vs Vds

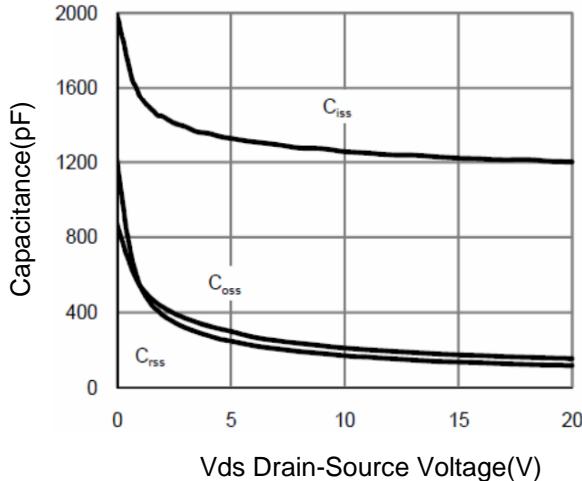
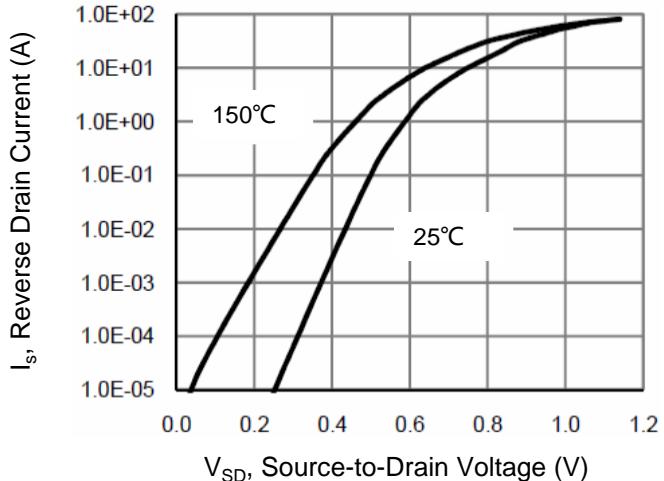


Figure 6. Source-Drain Diode Forward



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 7. Drain-Source On-Resistance

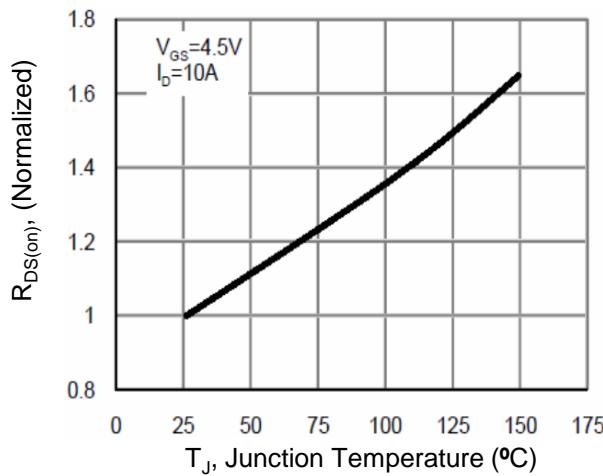


Figure 8. Safe Operation Area

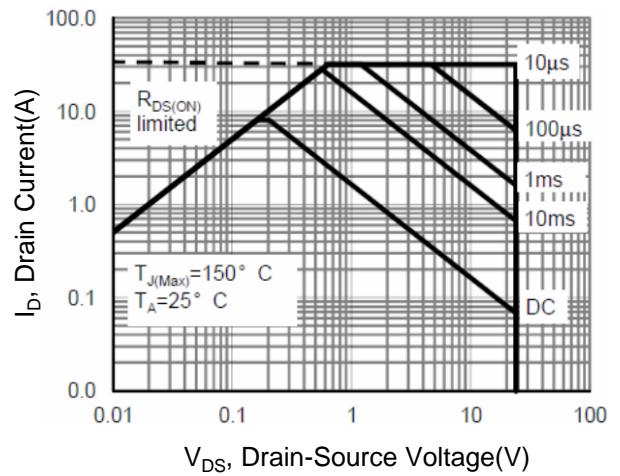
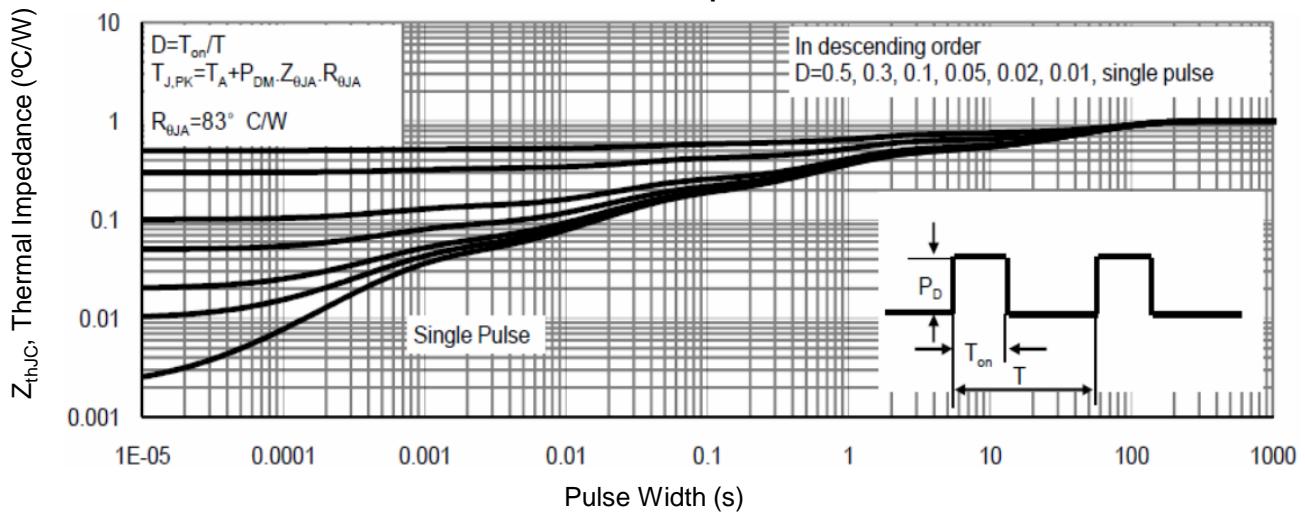
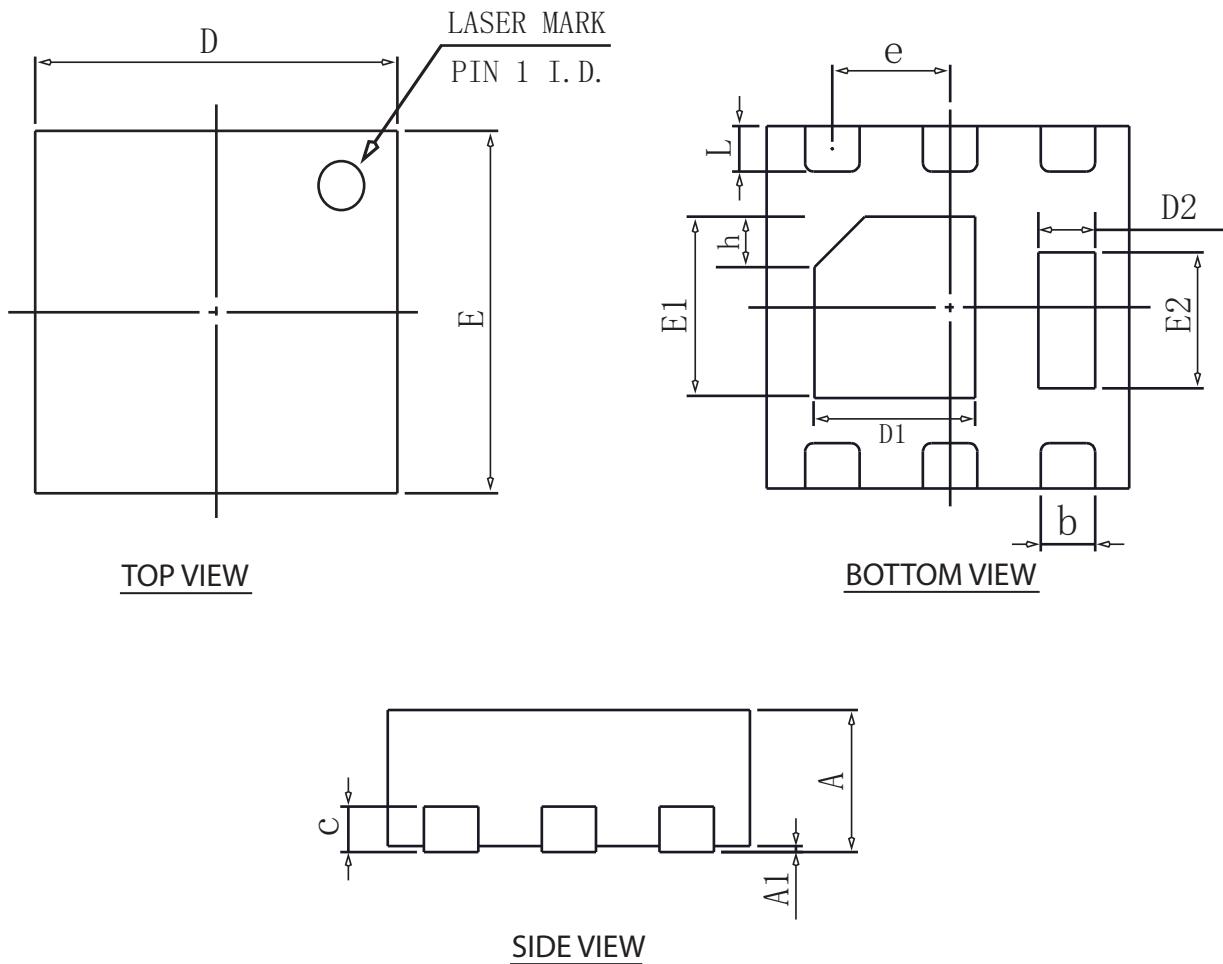


Figure 9. Normalized Maximum Transient Thermal Impedance



DFN2×2-6L Package Information



COMMON DIMENSIONS

SYMBOL	mm		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	NA	0.02	0.05
b	0.20	0.27	0.34
c	0.18	0.20	0.25
D	1.95	2.00	2.07
E	1.95	2.00	2.07
D1	0.80	0.90	1.00
E1	0.90	1.00	1.10
D2	0.20	0.30	0.40
E2	0.65	0.75	0.85
L	0.20	0.25	0.35
h	0.20	0.25	0.30
e	0.65BSC		